

APPLICATIONS

- Optical Power Measurement
- Spectroscopy
- Optical Testing
- Medical Diagnostics
- Fiber Optic receivers

AVAILABLE OPTIONS

- Through-Hole and Ceramic SMT Packaging
- Custom Lenses, Filters, and Anti-Reflective Coatings
- Fiber-Optic Packaging
- Integrated Electronics:
 - Thermo-Electric Cooler
 - Transimpedance Amplifier

Specifications

Germanium Photodiodes		
Optoelectronic Characteristics @ 23 °C ± 2 °C		
Spectral Response Range	800-1700	nm
Responsivity @ 850 nm (typ)	0.30	A/W
Responsivity @ 1300 nm (typ)	0.75	A/W
Responsivity @ 1550 nm (typ)	0.85	A/W
Linearity	10	dBm
Storage Temperature	-40 to 125	°C
Operating Temperature	-40 to 85	°C
Maximum Ratings @ 23 °C ± 2 °C		
Reverse Current	20	mA
Forward Current	10	mA

Figure 1. Responsivity vs. Wavelength

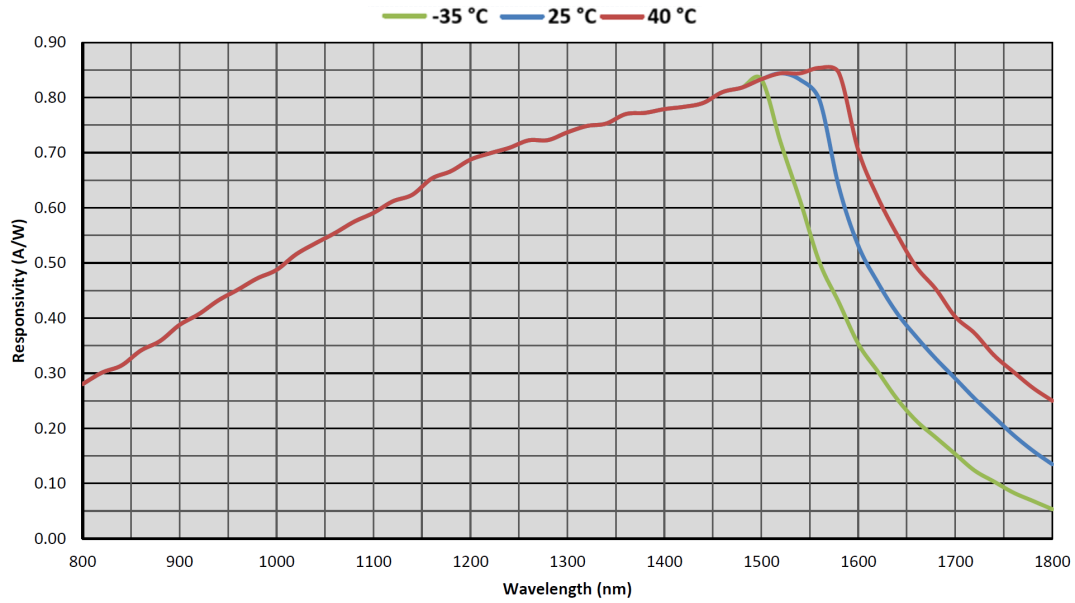


Figure 2. Capacitance vs. Reverse Bias

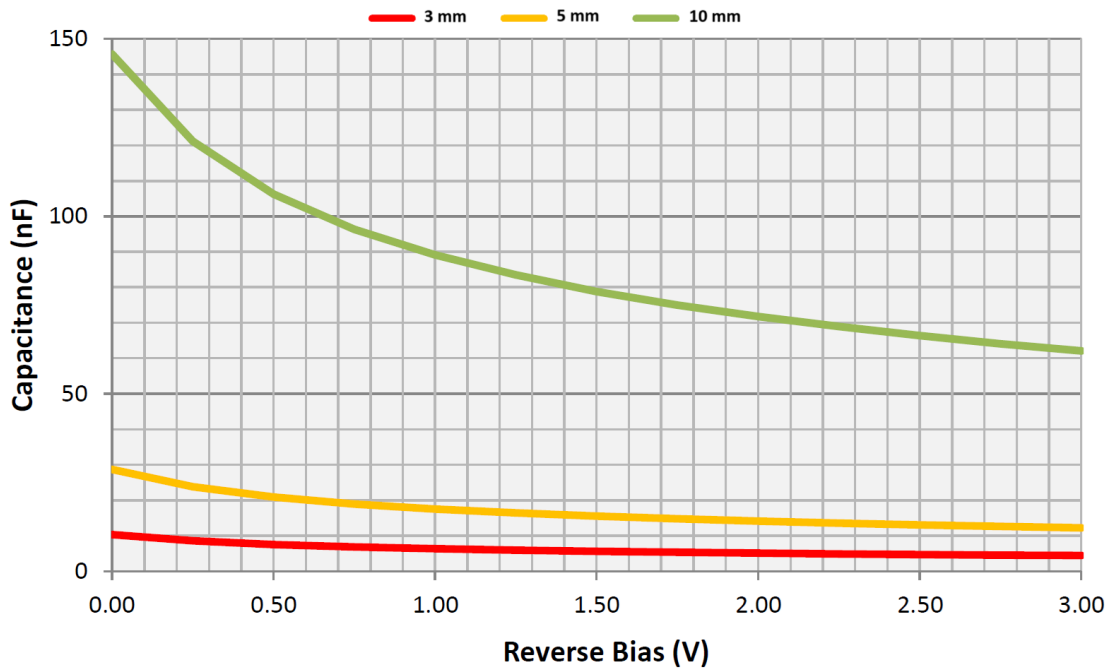


Figure 3. Dark Current vs. Reverse Bias

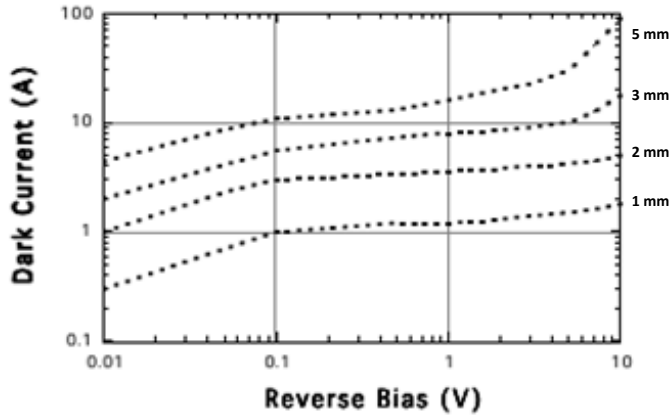


Figure 4. Shunt Resistance vs. Temperature

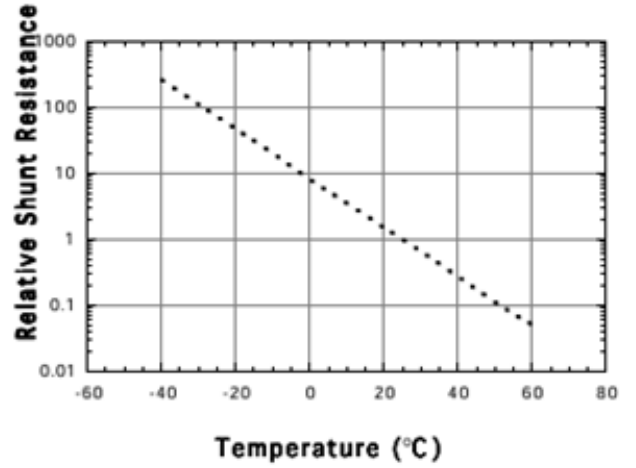
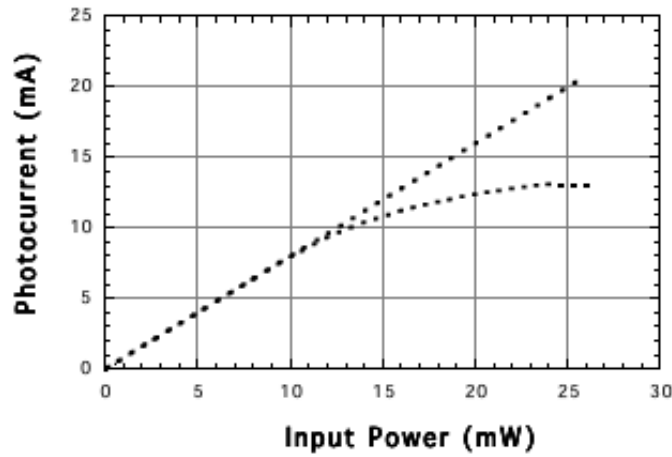


Figure 5. Photocurrent vs. Input Power



Packaging Capabilities

Packaging Configurations

Size	TO Headers					Ceramic Leadless Chip Carriers		BNC
	TO-46	TO-18	TO-5	TO-8	TO-9	LCC-6	LCC-28	
1 mm dia.	•	•				•		
2 mm dia.			•			•		
3 mm dia.			•				•	•
5 mm dia.				•			•	•
10x10 mm					•			•

Window (Other Options Available)

Material	Molded Clear Glass	Sapphire	Borosilicate Glass
Thickness (mm)	0.25	0.5	0.5

GPD QUALIFICATIONS

Our compliance, certificates, and capabilities

- ✓ ISO 9001:2015
- ✓ Quality Assurance Provisions
- ✓ DDTC/ITAR registered
- ✓ MIL-STD-883
- ✓ MIL-STD-750
- ✓ Space-qualified designs
- ✓ High-reliability assembly and environmental/radiation test
- ✓ Manufactured in Salem, NH

Specifications

1 mm Diameter Germanium Photodiode Performance Specifications				
Part Number	GB100-XX	GH100-XX	GV100-XX	
Optoelectronic Characteristics @ 23 °C ± 2 °C				Units
R _{SHUNT} @ 10mV (min/typ)	20/40	60/100	200/280	kΩ
I _{DARK} (max)	4	1.5	0.5	μA
Capacitance (max)	95	300	1500	pF
V _{REVERSE}	15	2	0.3	V
NEP (typ)	1.5	1	0.6	pW/Hz ^{1/2}
Maximum Reverse Voltage	15	3	0.3	V

2 mm Diameter Germanium Photodiode Performance Specifications				
Part Number	GB200-XX	GH200-XX	GV200-XX	
Optoelectronic Characteristics @ 23 °C ± 2 °C				Units
R _{SHUNT} @ 10mV (min/typ)	6/12	30/60	80/120	kΩ
I _{DARK} (max)	10	3	1	μA
Capacitance (max)	360	2200	7000	pF
V _{REVERSE}	10	2	0.3	V
NEP (typ)	3	1.4	0.8	pW/Hz ^{1/2}
Maximum Reverse Voltage	15	3	0.5	V

GB Series: Designed for high-speed applications with reverse bias >5V
GH Series: Designed for applications with reverse bias <5 V
GV Series: Designed for zero bias applications

Specifications

3 mm Diameter Germanium Photodiode Performance Specifications				
Part Number	GB300-XX	GH300-XX	GV300-XX	
Optoelectronic Characteristics @ 23 °C ± 2 °C				Units
R _{SHUNT} @ 10mV (min/typ)	4/8	25/35	40/65	kΩ
I _{DARK} (max)	20	4	2	μA
Capacitance (max)	1200	7000	14000	pF
V _{REVERSE}	5	1	0.25	V
NEP (typ)	4	2	1	pW/Hz ^{1/2}
Maximum Reverse Voltage	10	3	0.5	V

5 mm Diameter Germanium Photodiode Performance Specifications				
Part Number	GB500-XX	GH500-XX	GV500-XX	
Optoelectronic Characteristics @ 23 °C ± 2 °C				Units
R _{SHUNT} @ 10mV (min/typ)	2/4	10/15	15/20	kΩ
I _{DARK} (max)	30	10	5	μA
Capacitance (max)	3000	17000	40000	pF
V _{REVERSE}	3	1	0.1	V
NEP (typ)	5	3	2	pW/Hz ^{1/2}
Maximum Reverse Voltage	10	3	0.3	V

GB Series: Designed for high-speed applications with reverse bias >5V
GH Series: Designed for applications with reverse bias <5 V
GV Series: Designed for zero bias applications

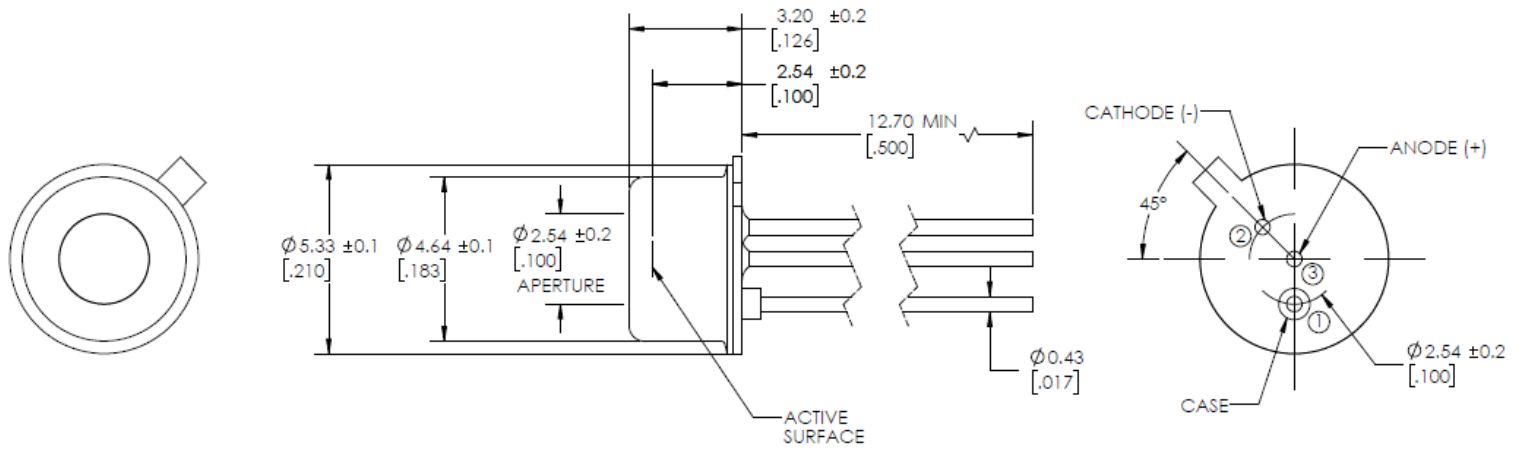
Specifications

10 x 10 mm Germanium Photodiode Performance Specifications				
Part Number	GB10M-XX	GH10M-XX	GV10M-XX	
Optoelectronic Characteristics @ 23 °C ± 2 °C				Units
R _{SHUNT} @ 10mV (min/typ)		2/3.5		kΩ
I _{DARK} (max)		50		μA
Capacitance (max)	Contact GPD for More Information	90000	Contact GPD for More Information	pF
V _{REVERSE}		0.5		V
NEP (typ)		6		pW/Hz ^{1/2}
Maximum Reverse Voltage		1		V

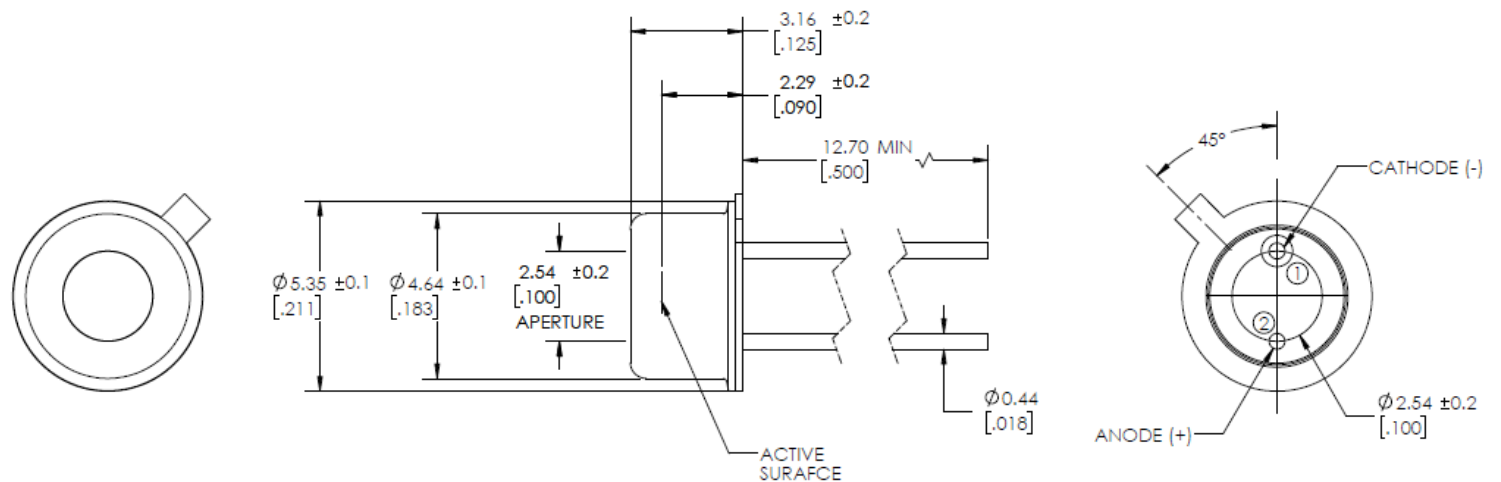
GB Series: Designed for high-speed applications with reverse bias >5V
GH Series: Designed for applications with reverse bias <5 V
GV Series: Designed for zero bias applications

Package Outlines

TO-46



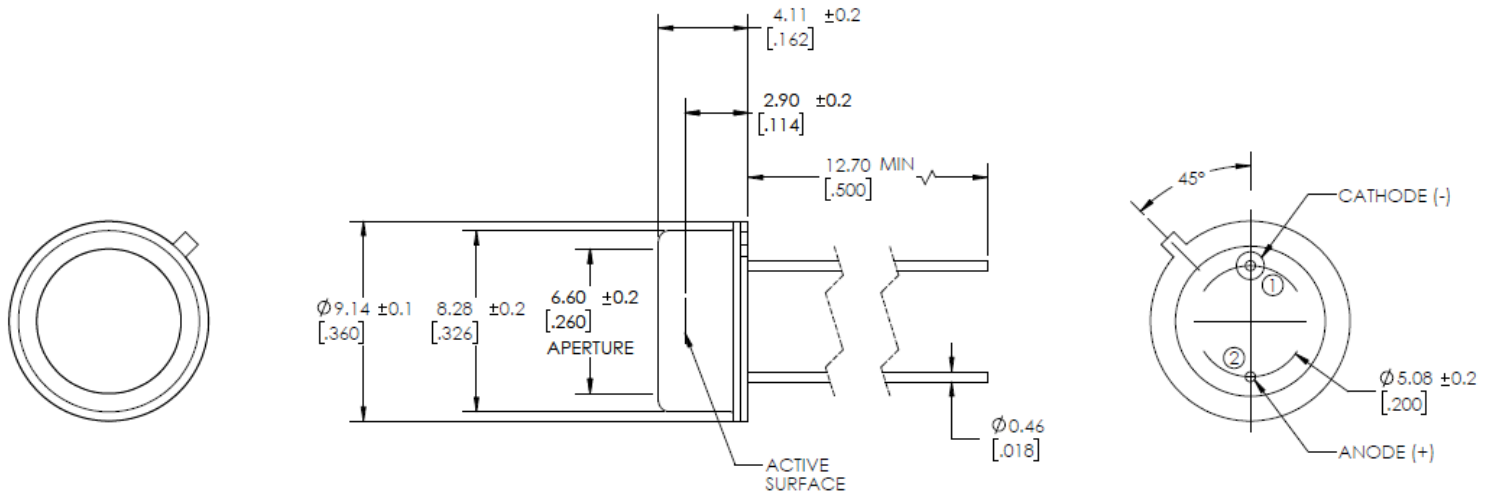
TO-18



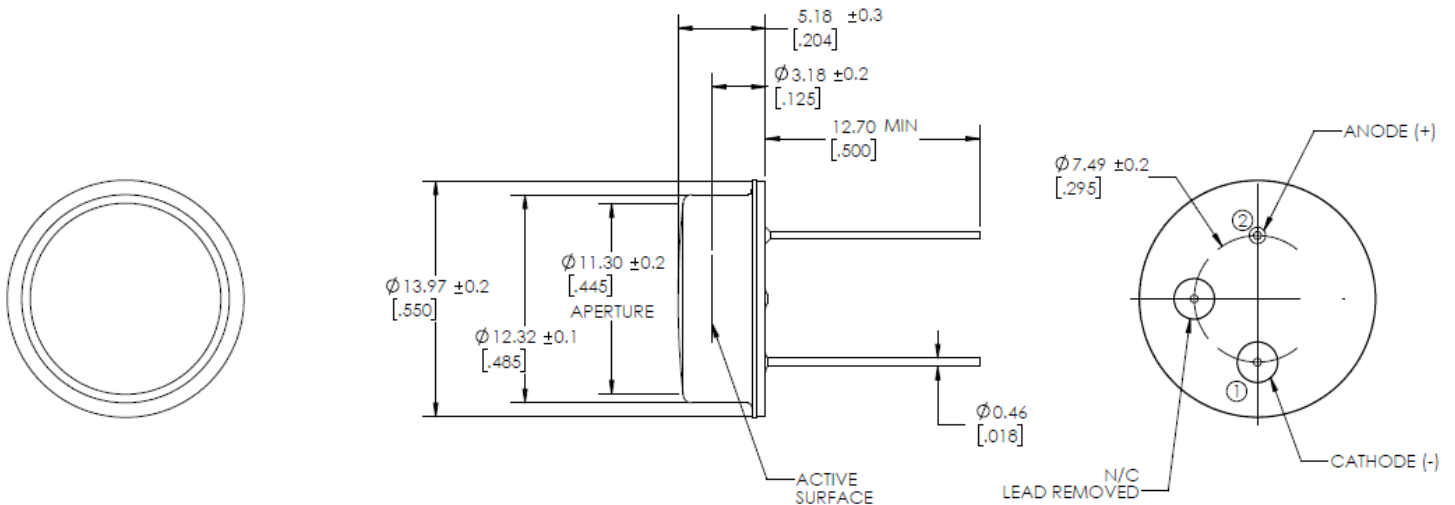
DIMENSIONS IN MM [INCH]

Package Outlines

TO-5



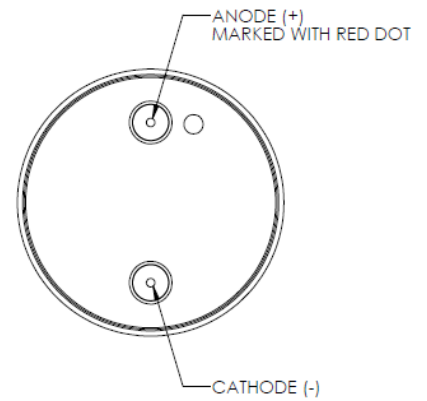
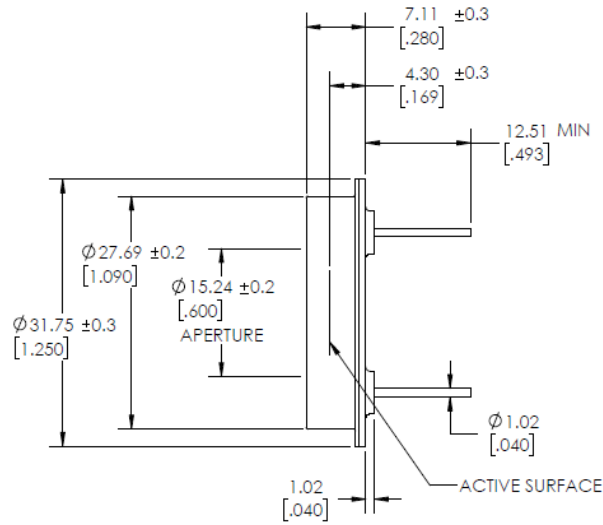
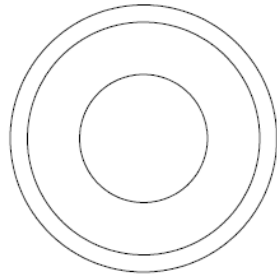
TO-8



DIMENSIONS IN MM [INCH]

Package Outlines

TO-9

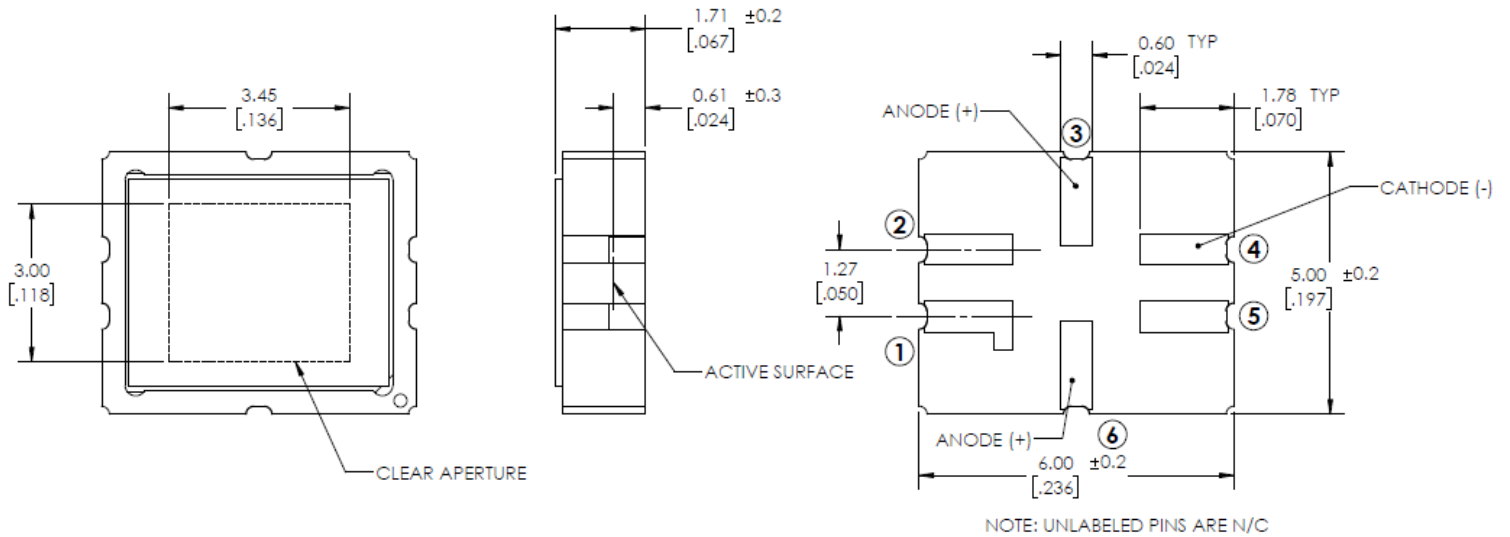


DIMENSIONS IN MM [INCH]

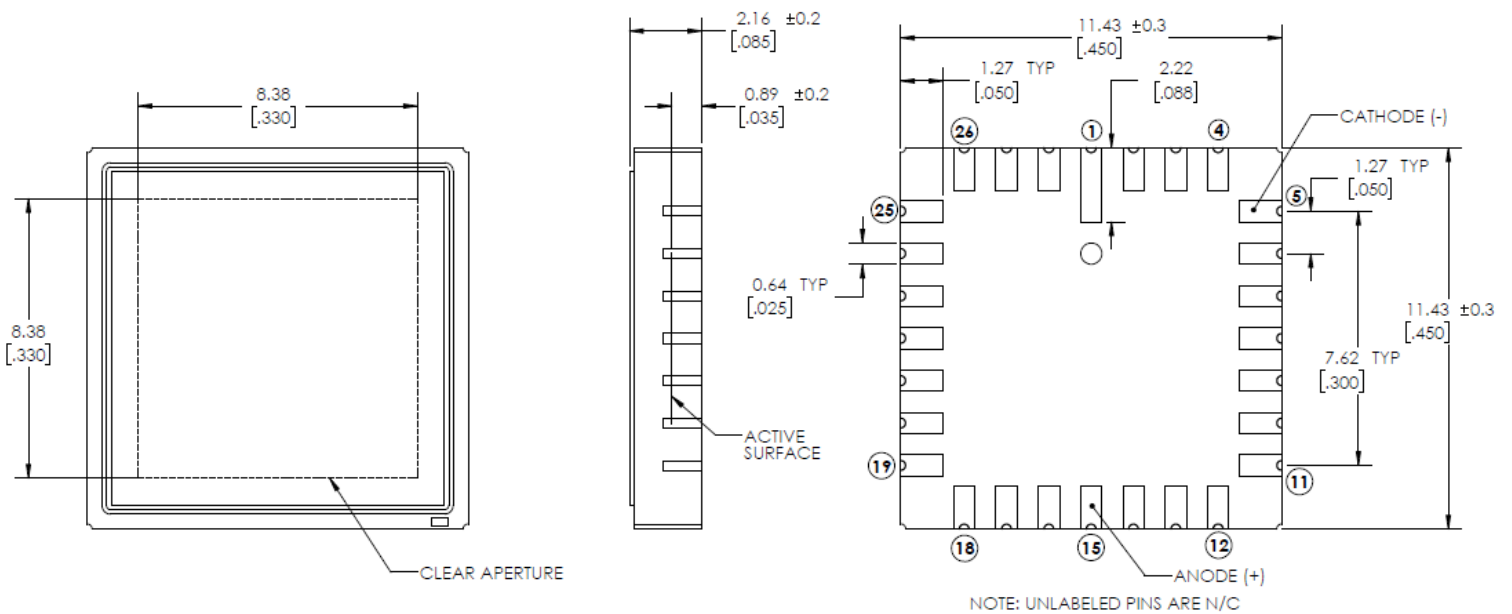


Package Outlines

LCC-6



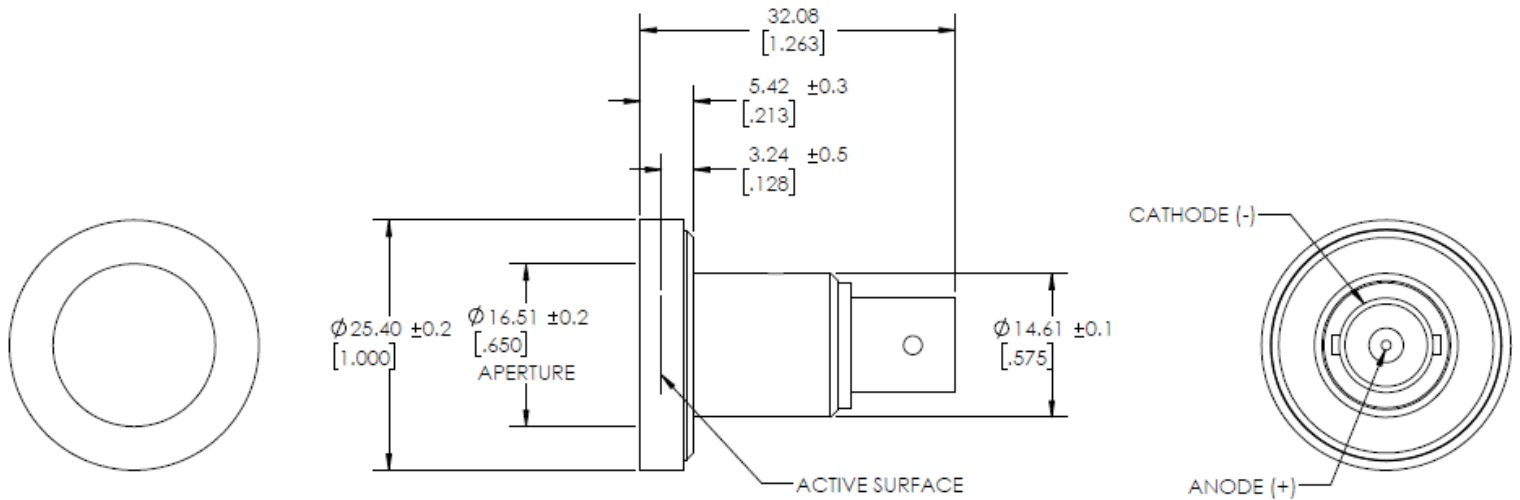
LCC-28



DIMENSIONS IN MM [INCH]

Package Outlines

BNC



DIMENSIONS IN MM [INCH]



Ordering Information

GPD is proud to offer multiple packaging solutions to best fit the needs of your application. Our Standard configurations are mentioned below, and custom packaging is also available.

Selection is based on the size of the photodiode and the package requirements of your application. Refer to packaging capabilities chart below for more information.

GB100-T46

Material	Performance	Diameter	Package*																																		
Germanium Photodiode	<p>B HB performance (formerly GM series) Designed for high-speed applications with reverse bias >5V</p> <p>H HS performance, Designed for applications with reverse bias <5 V</p> <p>V VHS performance, Designed for zero bias applications</p> <p>R VHR performance, Designed for zero bias applications requiring high shunt resistance</p> <p>C Custom performance</p>	<table border="1"> <tr><th>Diameter</th><th></th></tr> <tr><td>100</td><td>1 mm</td></tr> <tr><td>200</td><td>2 mm</td></tr> <tr><td>300</td><td>3 mm</td></tr> <tr><td>500</td><td>5 mm</td></tr> </table> <table border="1"> <tr><th>Square</th><th></th></tr> <tr><td>10M</td><td>10x10mm</td></tr> </table>	Diameter		100	1 mm	200	2 mm	300	3 mm	500	5 mm	Square		10M	10x10mm	<table border="1"> <tr><th>Package*</th><th></th></tr> <tr><td>T46</td><td>TO-46</td></tr> <tr><td>T18</td><td>TO-18</td></tr> <tr><td>T5</td><td>TO-5</td></tr> <tr><td>T8</td><td>TO-8</td></tr> <tr><td>T9</td><td>TO-9</td></tr> <tr><td>LCC6</td><td>6 contact</td></tr> <tr><td>LCC28</td><td>28 contact</td></tr> <tr><td>BNC</td><td>BNC</td></tr> <tr><td>CS</td><td>Ceramic Substrate</td></tr> </table> <p>*More packages available upon request</p>	Package*		T46	TO-46	T18	TO-18	T5	TO-5	T8	TO-8	T9	TO-9	LCC6	6 contact	LCC28	28 contact	BNC	BNC	CS	Ceramic Substrate
Diameter																																					
100	1 mm																																				
200	2 mm																																				
300	3 mm																																				
500	5 mm																																				
Square																																					
10M	10x10mm																																				
Package*																																					
T46	TO-46																																				
T18	TO-18																																				
T5	TO-5																																				
T8	TO-8																																				
T9	TO-9																																				
LCC6	6 contact																																				
LCC28	28 contact																																				
BNC	BNC																																				
CS	Ceramic Substrate																																				

NOTE: GPD Optoelectronics may update product details without prior notice, and any use or application of our products is at your own discretion.

Handling and Processing Precautions

Electrostatic Discharge (ESD) Warning

Our detectors are highly susceptible to damage from electrostatic discharge (ESD). To prevent damage, use ESD protective measures, such as grounding straps, when unpacking and handling these devices.

To guarantee the optimal performance of a photodiode, it is crucial to adhere strictly to the device's electrical specifications. Photodiodes are highly sensitive to values that surpass their absolute maximum ratings. Exceeding these limits can lead to damage or total failure of the device. Users should employ handling techniques that avoid electrostatic discharges and other electrical surges during both the handling and operation of these devices.

Cleanroom Packaging and Handling

Our detectors are packaged in a clean state under cleanroom conditions, eliminating the need for cleaning before processing. In fact, cleaning is not recommended as it may introduce contaminants.

Processing Guidelines

To maintain the cleanliness of our detectors:

- Process under the cleanest conditions possible, including clean workplaces and room air.
- Wear suitable gloves or fingerstalls to prevent fingerprint contamination (mainly fats and organic acids).
- Ensure the soldering process is designed to prevent the need for post-soldering cleaning.

Cleaning Optical Windows (if necessary)

If exceptional circumstances require cleaning the optical windows:

- First, identify the type of contamination.
- For loose particles, gently blow them off with nitrogen gas or clean, dry air.
- For attached particles or other contaminating materials, clean with solvents such as isopropyl alcohol, or First Contact™ Polymer